

Part-No.

M11E9001

Dominant

Wavelength (nm)

or CCT(K)

Тур

7000

3. Tolerance of measurement of CCT (Correlated color temperature +/- 200K

Min

6000

1. Tolerance of measurement of luminous flux : +/-15%

4. Tolerance of measurement of forward voltage +/-0,1V



Luminious Flux

(lm)

Тур

200

 ∞

ιc

Rever-

se Cur-

rent

(µA)

max

10

50%

Power

Angle

Тур

120

0

2. Tolerance of measurement of dominant Wavelength : +/-1nm

0~+0.07 Ma

Typical Electrical & Optical Characteristics (IF=700mA and Ta=25°C)

Min

180

Technical Dimensions

Forward Voltage

(V)

Max

4.0

Min

3.3

10





Features

Highest Luminous Flex Long Lifetime Operation Super Energy Efficency Superior UV Resistance Superior ESD protection

Absulut Maximum Ratings (Ta=25°C)

Items	Symb ols	Absulut maximum Rating	Unit
	015	Cool White	
Power Dissipation	Pd	3200	mW
Forward Current	lf	800	mA
Peak Forward Current	lfp	1000	mA
Reverse Voltage	Vr	5	V
LED Junction Temperature	Tj		°C
Operating Temperature	Topr	-30°C ~ +85°C	°C
Storage Temperature	Tstg	-40°C ~ +100°C	°C

* Pulse width \leq 0,1msec duty \leq 1/10

Anode(+) Cathode(-)										-	Power LED
		1								Part No.:	M11E9001
DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.07.2010	Customer:	
APPD:	Schumi			FINISH	Jamy		Shee	t No.	1 110111 10		

www.edcon-components.com

Copyright by EDCON-COMPONENTS









Max

										DIL			TEOW								
Code	Lu	Luminous Flux Range Code Luminous Flux		Flux Ran	ge				C.	ode		CCT Ran	ge		Code	C	CT Range				
Code	m	nin	m	ax.	Code	m	nin	m	ax.	15%				bde	N	lin	Ma	ax	Jode	Min	Ma
А		1	:	2	P2	7	0	8	30	12				Ą	27	'00	29	00	М	4900	510
В	:	2	2	,5	M1	8	80	g	90	is +/-				В	29	00	31	00	Ν	5100	550
С	2	2,5	3	,2	M2	9	90	1	00				(C	31	00	33	00	Р	5500	600
D	3	3,2	4	4	N1	1(00	1	10	measurement of luminous Flux			I	D	33	00	35	00	Q	6000	650
Е	4	4	Į	5	N2	1'	10	1:	20	inor				E	35	00	37	00	R	6500	700
F	į	5	6	,2	P1	12	20	1;	30	iūr				F	37	'00	39	00	S	7000	750
G	6	i,2	7	,7	P2	1:	30	1.	40	of Ir			(G	39	00	41	00	Т	7500	800
Н	7	7,7	9	,6	Q1	14	40	1	50	ent			ł	4	41	00	43	00	U	8000	900
J	9	9,6	1	2	Q2	1:	50	1	60	ē				J	43	600	45	00	V	9000	100
К	1	2	1	5	R1	16	60	1	70	asur				K	45	00	47	00	W	10000	120
L1	1	15	1	9	R2	17	70	1	80	mea			l	L	47	'00	49	00			
L2	1	19	2	24	S1	18	80	2	00	of			Tolerand	ce of mea	suremen	t of CCT is +	/-100ŀ	κ.			
M1	2	24	3	80	S2	20	00	2	20	Tolerance											
M2	3	30	4	10	T1	22	20	2	40	lera											
N1	4	40	5	50	T2	24	40	2	60	To											
N2	5	50	6	60	U1	2	50	2	80												
P1	6	60	7	0												_					
		I	В		Н	G	/E		F		Y	C)/P	R	/U						
Color	Code	Min	max	Min	max	Min	max	Min	max	Min	max	Min	max	Min	max	ient of +/-1nm					
D	0	450	455	490	495	515	520	560	565	580	583	600	605	620	625	measurement of elength is +/-1nn					
D	1	455	460	495	500	520	525	565	570	583	586	605	610	625	630						
D	2	460	465	500	505	525	530	570	575	586	589	610	615	630	635	asul gth					
D	3	465	470	505	510	530	535	575	580	589	592	615	620	635	640	mea					
D4	4	470	475	510	515	535	540			592	595			640	645	Tolerance of measurem dominant wavelength is					
D	5	475	480			540	545			595	598			645	650	nt w					
De	6	480	485			545	550							650	655	lera				Tops Po	wer LED
D	7	485	490			550	555							655	660	don To				-	
D	8					555	560							660	665	Ŭ			Part N	0.:	M11E900
DR	W:	Jas	son	C⊦	IKD	Wil	son	MA	TL:	Wi	lson	TOLE	RANCE	Ma	son	DATE		12.07.2010	Custores		
APF	PD:	Sch	numi					FIN	IISH	Ja	imy	1			Shee	t No.		2 from 10	Custome	H.	
vww.ed	dcon-c	ompone	ents.co	m															email: info	@edcon	-component

BIN GUIDE / HIGH POWER

Copyright by EDCON-COMPONENTS

o@edcon-components.com emaii.

M11E9001







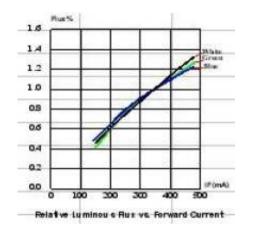
The Power of LED Light

COMPONENTS A MEMBER OF EDCON-GROUP

IF(mA)

500

Typical Electrical / Optical Characteristics Curves (Ta=25°C Unless otherwise noted)



Ring-America Ca

RING-AWER CA

RING-AMOTICAN

Rthu-Ardo" CW

(FunA)

400

30

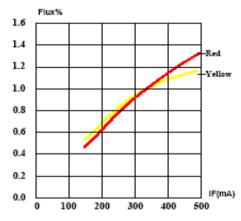
300

22

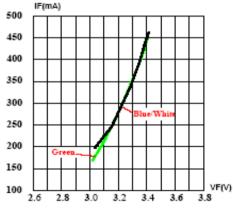
21

10

Current Derating Curves



Relative Luminous Flux vs. Forward Current





Forward Voltage Rank Code Min. Max. А 1.6 1.8 В 1.8 2,0 С 2,0 2,2 D 2,2 2,4 Е 2,4 2,6 F 2,6 2,8 G 2,8 3.0 Н 3,0 3.2

Tolerance of measurement of forward voltage is +/-0,1V

450 400 350 300 250 200 ellos 150 VF(V) 100 2.0 2.2 2.4 2.6 2.8 3.0 1.8 Forward Current vs. Forward Voltage

Code	Forward Voltage Rank							
Code	Min.	Max.						
J	3,20	3,40						
К	3,40	3,60						
L	3,60	3,80						
М	3,80	4,00						
N	4,00	4,20						
Р	4,20	4,40						
Q	4,40	4,60						
R	4,60	4,80						

- 50 **Tops Power LED** 75 25 50 100 125 15 Part No.: M11E9001 DRW: CHKD Wilson MATL: TOLERANCE 12.07.2010 Wilson Mason DATE Jason Customer: APPD: FINISH Schumi Sheet No. 3 from 10 Jamy

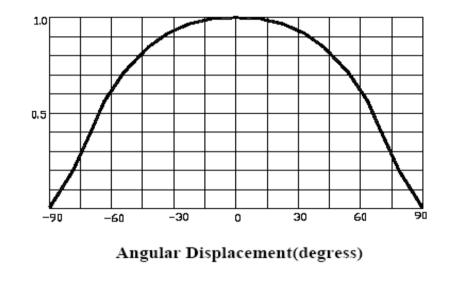
www.edcon-components.com

Copyright by EDCON-COMPONENTS

120



Typical Representative Spatial Radiation Paddern of single LED

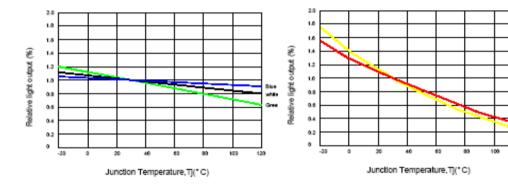




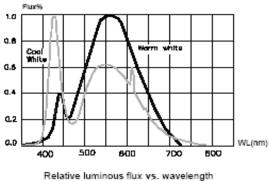


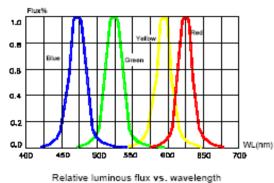
The Power of LED Light

Light Output Characteristics



Wavelength Characteristics





Tops Power LED Part No.: M11E9001 CHKD Wilson MATL: Wilson TOLERANCE Mason 12.07.2010 Jason DATE Customer: FINISH Sheet No. 4 from 10 Schumi Jamy

www.edcon-components.com

DRW:

APPD:

Copyright by EDCON-COMPONENTS









Handling Informations

- 4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although ist characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of th LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools



2. Do not directly touch or handle the silicone lens surfance. It may damage the internal circuitry.

\bigcap	\int
5	1
	R
	\geq

3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratsch the silicone lens or damage the internal circuitry.



Tops Power LED

M11F9001

Part No ·

_												
	DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.07.2010	Customor	
	APPD:	Schumi			FINISH	Jamy		Shee	et No.	5 from 10	Customer:	

www.edcon-components.com

Copyright by EDCON-COMPONENTS







Moisture Proof Packing

In Order to prevent moisture absorption into DIAMOND = TOP LED / XEON POWER during the transportation and storage. DIAMOND TOP-LED / XEON-POWER LED is packed in a moisture barrier bag. Desiccants and humidity indicator are packed together with DIAMOND TOP-LED / XEON-POWER LED as the secondary protection. The indication of humidity card provides the information of humidity within TOP Packing.

Storage

Shelf life in original sealed bag in storage condition of <40°C and 90% RH is 12 mounths. Baking is required whenever shelf life is expired. Before opening the packaging please check wether bag leak air or not. After opening the DIAMOND TOP-LED / XEON POWER LED must be storad under the condition <30°C and 60% RH. Under this condition DIAMOND TOP-LED / XEON POWER LED must be used (subject to reflow) within 24-hours after bag opening, and re-baking is required when exceeding 24 hours. For baking, place DIAMOND TOP-LED / XEON POWER LED in oven at temperature 75°C +/-5°C and relative humidity <10%RH, for 24 hours. Take out the material from packaging bag for re-bake. Do not open the door of oven frequently during the baking process.

Manual soldering (We do not recommend this method strongly).

No mechanical stress should be exerted on the resin portion of DIAMOND TOP-LED / XEON POWER during soldering.

Handling of DIAMOND TOP-LED / XEON POWER LED should be done when the package has been cooled down to below 40°C or less. This is to prevent the DIAMOND

TOP-LED / XEON POWER failures due the thermal-mechanical strss during handling.

Reflow soldering should not be done more than one time.

No stress should be exerted on the package during soldering.

Electrostatic Discharge and Surge current.

Electrostatic discharge (ESD) or surge current (EOS) may damage LED.

Precautions such as ESD wrist strap, ESD shoe strap or antistatic gloves must be worn whenever handling DIAMOND TOP-LED / XEON POWER LED.

All devices, equipment and machinery must be prpertly grounded.

It is recommended to perform electrical test to screen out ESD failures in final inspection.

It is importate to eliminate the possibility of surge current during circuity design.

Heat Management

Heat management of DIAMOND TOP-LED / XEON POWER must be taken into into consideration during the design stage of DIAMOND TOP-LED / XEON POWER LED application. The current should be de-rated appropriately by refering to the de-rating curve attached on each product specification.

										Tops F	Power LED
										Part No.:	M11E9001
DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.07.2010	Customer:	
APPD:	Schumi			FINISH	Jamy		Shee	t No.	6 from 10	Customer.	
www.edcon-c	omponents cor	n							e	mail info@edco	n-components com

Copyright by EDCON-COMPONENTS

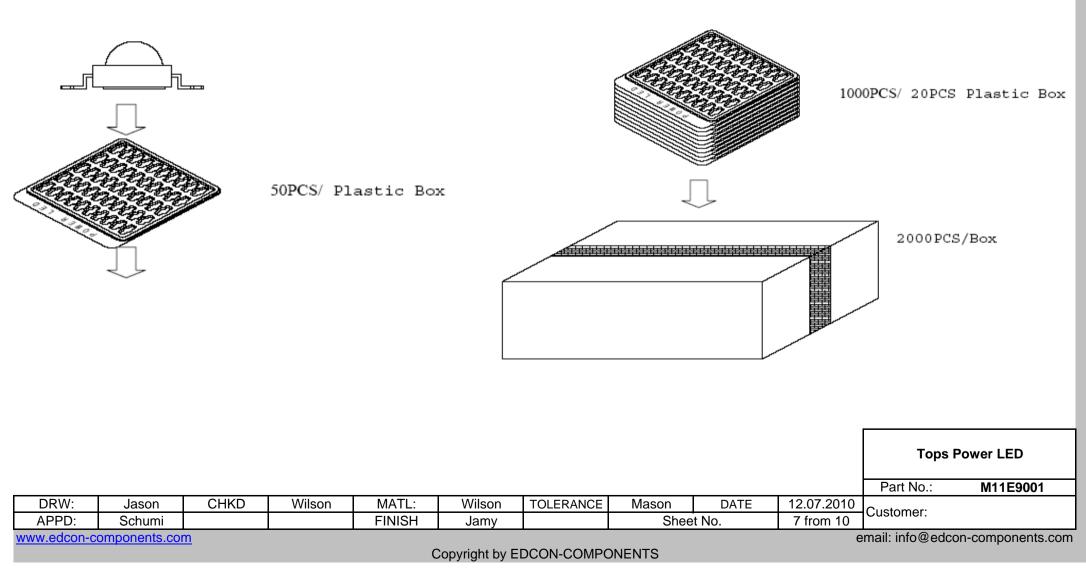








Packing Specifications









Ordering Informations

Serie	Color Code	ROHS	Packing				
M11E9001	CW	R	TR				

CW	R= ROHS	TR= TAPE
=	Conform	REEL
Cool White	N= NON	BU= Bulk-
	ROHS	Ware

-											Part No.:	M11E9001
	DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.07.2010	Customer:	
	APPD:	Schumi			FINISH	Jamy		Sheet No. 8 from		8 from 10	Customer.	

www.edcon-components.com

Copyright by EDCON-COMPONENTS

email: info@edcon-components.com

Tops Power LED

A MEMBER OF EDCON-GROUP

Soldering Profile Curve

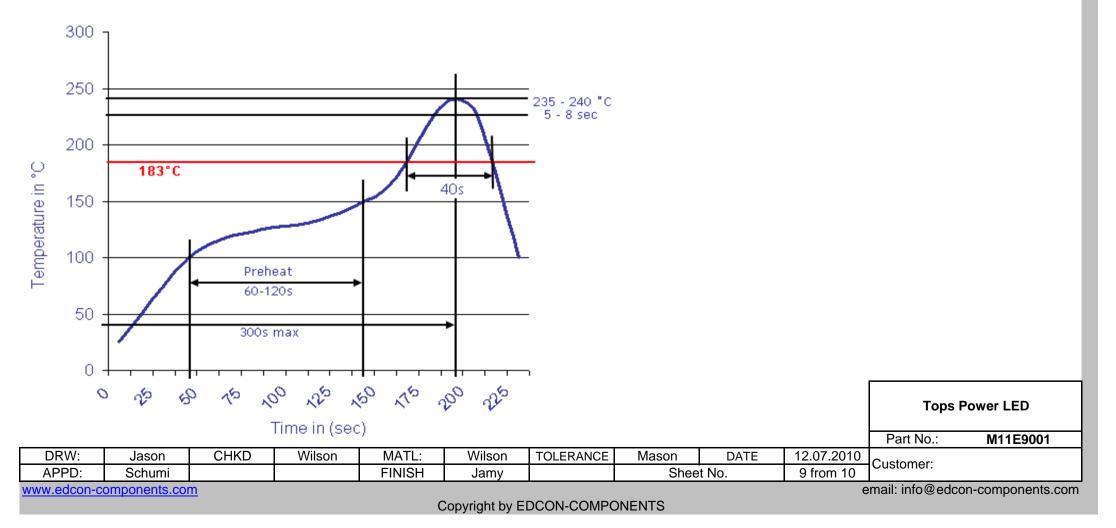








Classification Reflow Profile (JEDEC J-STD-020C)



Spectral Color Curve



DRW:

APPD:

CHKD

Jason

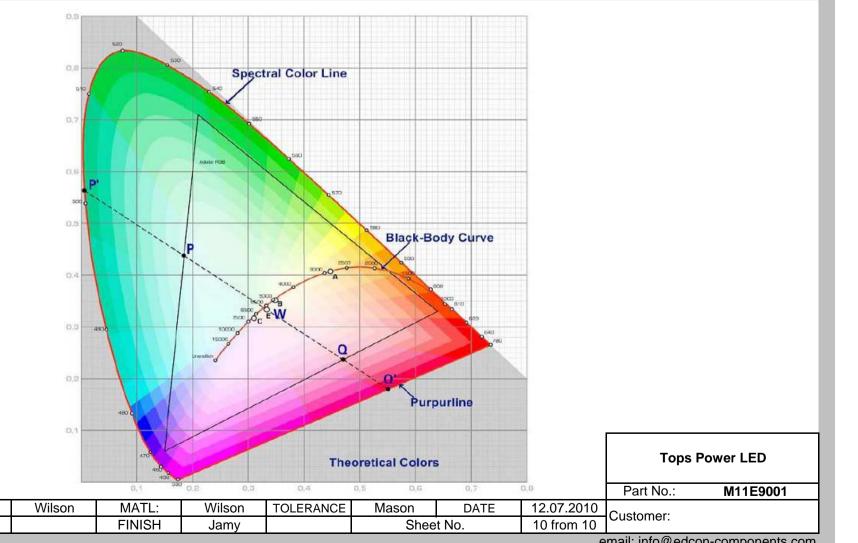
Schumi

www.edcon-components.com





The Power of LED Light



Copyright by EDCON-COMPONENTS

email: info@edcon-components.com

COMPONENTS A MEMBER OF EDCON-GROUP